



Product End-of-Life Disassembly Instructions

Product Category: Networking Equipment

Marketing Name / Model
[List multiple models if applicable.]

HP A5120-8G-POE+ SI Switch (JG309A)

HP 1910-8G-PoE+ (180W) Switch (JG350A)

Purpose: The document is intended for use by end-of-life recyclers or treatment facilities. It provides the basic instructions for the disassembly of HP products to remove components and materials requiring selective treatment, as defined by EU directive 2002/96/EC, Waste Electrical and Electronic Equipment (WEEE).

1.0 Items Requiring Selective Treatment

1.1 Items listed below are classified as requiring selective treatment.

1.2 Enter the quantity of items contained within the product which require selective treatment in the right column, as applicable.

Item Description	Notes	Quantity of items included in product
Printed Circuit Boards (PCB) or Printed Circuit Assemblies (PCA)	With a surface greater than 10 sq cm	2
Batteries	All types including standard alkaline and lithium coin or button style batteries	0
Mercury-containing components	For example, mercury in lamps, display backlights, scanner lamps, switches, batteries	0
Liquid Crystal Displays (LCD) with a surface greater than 100 sq cm	Includes background illuminated displays with gas discharge lamps	0
Cathode Ray Tubes (CRT)		0
Capacitors / condensers (Containing PCB/PCT)		0
Electrolytic Capacitors / Condensers measuring greater than 2.5 cm in diameter or height		0
External electrical cables and cords		0
Gas Discharge Lamps		0
Plastics containing Brominated Flame Retardants weighing > 25 grams (not including PCBs or PCAs already listed as a separate item above)		2
Components and parts containing toner and ink, including liquids, semi-liquids (gel/paste) and toner	Include the cartridges, print heads, tubes, vent chambers, and service stations.	0
Components and waste containing asbestos		0
Components, parts and materials containing refractory ceramic fibers		0
Components, parts and materials containing radioactive substances		0

2.0 Tools Required

List the type and size of the tools that would typically be used to disassemble the product to a point where components and materials requiring selective treatment can be removed.

Tool Description	Tool Size (if applicable)
Screw driver	2#

3.0 Product Disassembly Process

3.1 List the basic steps that should typically be followed to remove components and materials requiring selective treatment:

1. Unscrew the Power Cable Holder 1.
2. Unscrew all screws 2 on cover 3, and then remove cover 3.
3. Unplug all of the inner cable connectors.
4. Unscrew the screws of Fan on Part 7, and then remove 4 from the part 7.
5. Unscrew the screws on Power rack 5, and then remove 5 from the part 7.
6. Unscrew the screws of Fan rack on Part 7, and then remove 6 from the part 7.
7. Unscrew the screws on Power module, and then remove 8 from the part 7.
8. Unscrew the screws on PCB, and then remove 9 from the part 7.
9. Remove AC cable connector 10 and cable holder set 11 from the part 7.
10. Remove the cable holder set 11 from AC cable connector 10.
11. Remove front film from the part 9.
12. Remove all the labels from the chassis.
13. Unscrew the screws 6-1 of Fan rack, and then remove 6-3 from the part 6-2.

3.2 Optional Graphic. If the disassembly process is complex, insert a graphic illustration below to identify the items contained in the product that require selective treatment (with descriptions and arrows identifying locations)

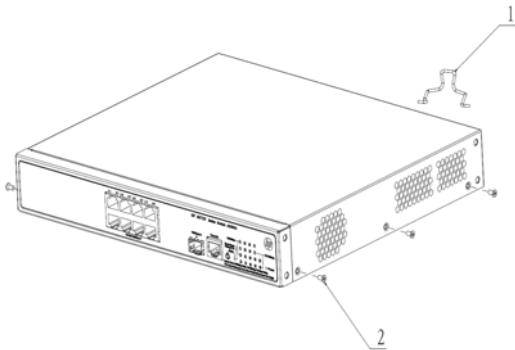


Figure 1 Unscrew the Power Cable Holder 1 and screw 2

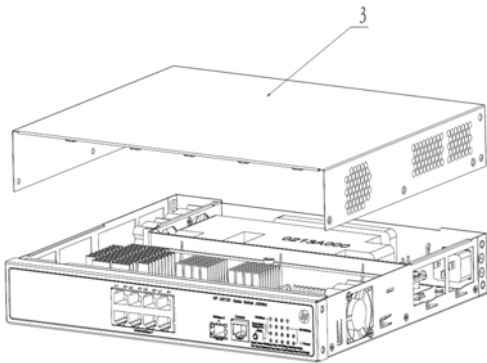


Figure 2 Remove Cover 3

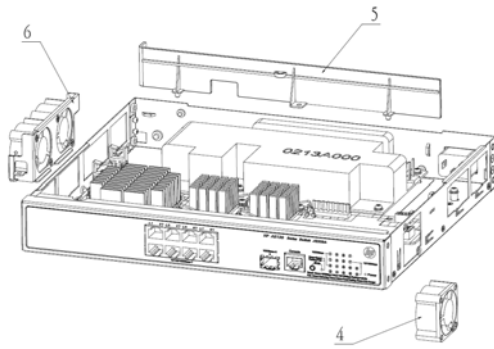


Figure 3 Remove the Fan and Part 5

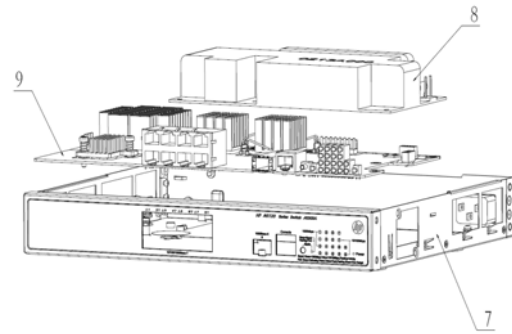


Figure 4 Remove the PCB and Power Module

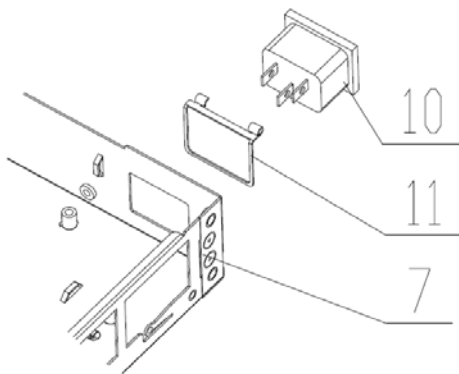


Figure 5 Remove the Cable connector

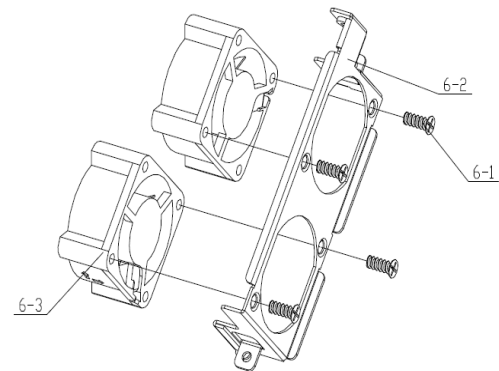


Figure 6 Remove the Fan from Fan rack